

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3848445

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHEREEF SHEHATA	04/26/2016
SANDEEP KUMAR GOEL	04/25/2016
TZE-CHIANG HUANG	04/22/2016
YUN-HAN LEE	04/12/2016
MEI WONG	04/26/2016
RECEIVING PARTY DATA	
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	NO. 8, LI-HSIN RD. VI, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15099941
CORRESPONDENCE DATA	
Fax Number:	(703)518-5499
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ATTORNEY DOCKET NUMBER:	T5057-1194
NAME OF SUBMITTER:	RANDY A. NORANBROCK
SIGNATURE:	/Randy A. Noranbrock/
DATE SIGNED:	04/27/2016
Total Attachments: 2	

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ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- | | |
|-----------------------|----------------|
| 1) Shereef SHEHATA | 4) Yun-Han LEE |
| 2) Sandeep Kumar GOEL | 5) Mei WONG |
| 3) Tze-Chiang HUANG | |

who has made a certain new and useful invention, hereby sells, assigns and transfers unto TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD., having a place of business at No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

POWER CONSUMPTION ESTIMATION METHOD FOR SYSTEM ON CHIP (SOC), SYSTEM FOR IMPLEMENTING THE METHOD

(a) for which an application for United States Letters Patent was filed on 2016-04-15, and identified by United States Patent Application No. 15/099,941; or

(b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) 
Name: Shereef SHEHATA

04/26/2016
Date:

2) 
Name: Sandeep Kumar GOEL

04/25/2016
Date:

3) 
Name: Tze-Chiang HUANG

4/22/2016
Date:

4) _____
Name: Yun-Han LEE

Date:

5) 
Name: Mei WONG

4/26/2016
Date:

Docket No. P20160018US00
TS057-1194

ASSIGNMENT

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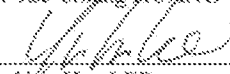
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| 1) _____
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| 3) _____
Name: Tze-Chiang HUANG | _____
Date: |
| 4) 
Name: Yun-Han LEE | <u>04/12/2016</u>
Date: |
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Date: |